

**\*\*EXTENDED DEADLINE- 27 July 2026\*\***

# **IEEE JOURNAL ON EMERGING AND SELECTED TOPICS IN CIRCUITS AND SYSTEMS**

## **Call for PAPERS**

### **When Large Models Meet Video Coding: Synergies, Systems, and Hardware Challenges**

#### **Guest editors**

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#### **Rationale, motivation, and scope**

Large Models (LMs), including LLMs and multimodal LLMs (MLLMs), have revolutionized artificial intelligence, opening new frontiers in video compression, synthesis, and enhancement. While algorithmic advances are significant, their real-world impact hinges on efficient, scalable, and secure hardware and system implementations. The exponential growth of model size and video data demands novel hardware solutions, real-time processing, and low-power designs for edge and mobile applications.

This special issue focuses on the circuits, architectures, and systems that enable LM-driven video coding—addressing challenges in energy efficiency, memory bandwidth, real-time processing, hardware-aware optimization, and system-level robustness. It aims to provide a forum for pioneering research at the intersection of large models, video compression, and circuits and systems, uniquely centered on hardware, co-design, and system integration rather than purely algorithmic advances.

#### **Topics of interest**

Topics of interest to this special issue include, but are not limited to:

- **Hardware/System Architectures:** ASIC/FPGA/GPU and accelerator designs for neural and generative video codecs; in-memory computing; near-sensor processing; System-on-Chip (SoC) integration.

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- **Hardware-Aware Optimization & Co-Design:** Quantization, pruning, and tokenization for hardware-friendly LMs; complexity-accuracy trade-offs; latency and throughput optimization for edge/cloud deployments.
- **Memory, Bandwidth & Energy Efficiency:** Memory hierarchy optimization; bandwidth reduction techniques; energy-efficient coding for battery-constrained devices; green computing strategies.
- **System-Level Security, Reliability & Deployment:** Hardware security for AI-based video systems (e.g., adversarial resilience); fault-tolerant architectures; robustness against compression artifacts and deepfakes.
- **Large Models for Video Coding & Processing:** Neural video compression; generative and diffusion models for low-bitrate streaming; dynamic bitrate adaptation.
- **Video Coding Techniques for Improving LMs:** Efficient video compression to accelerate LM training/inference; latent-space video representations; new tokenization methods.
- **Emerging Applications:** LM-powered coding for VR/AR, automotive, medical, and UAV systems; standardization-ready hardware implementations.

### **Submission procedure**

Prospective authors are invited to submit their papers following the instructions provided on the IEEE JETCAS website: <https://ieee-cas.org/publication/JETCAS/manuscript-submission-guide>. The submitted manuscripts should not have been previously published, nor should they be currently under consideration for publication elsewhere. The IEEE JETCAS submission site is <https://ieee.atyponrex.com/journal/jetcas>.

### **Important dates**

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|--------------------------------------|-------------------------------|--------------------|
| • Manuscript submissions due:        | <del>June 1, 2026</del>       | July 27, 2026      |
| • First round of reviews completed:  | <del>July 20, 2026</del>      | August 31, 2026    |
| • Revised manuscripts due:           | <del>August 31, 2026</del>    | September 30, 2026 |
| • Second round of reviews completed: | <del>September 28, 2026</del> | October 31, 2026   |
| • Final manuscripts due:             | <del>October 19, 2026</del>   | November 30, 2026  |

### **Request for information**

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